Amphenol's SFP interconnect system consists of a 20-position connector enclosed in a metal cage mounted to a host PCB.

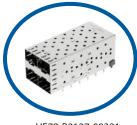
Amphenol's stacked SFP combos are rated up to 6 Gbps. The connector accepts multiple transceivers per INF-8074i and combines, transmits, and receives functions in a low cost, compact, and flexible format. The cages have a two-piece construction with enhanced transceiver mating tabs available in a press-fit version or a solder tail version. Longer and shorter pins are available as custom options. Stacked versions (2xN) consist of a 2-row cage with integrated 2-row connectors.



UE78-B8126-00321



UE78-L1126-00321



UE78-B2127-00321

Specification Highlights

The interconnect system is comprised of a cage assembly which is used with 20-position SFP connectors complying with MSA Agreement INF-8074i.

General Characteristics

- RoHS Compliant
- Industry Standard Footprint
- Industry Standard EIA-364

Mechanical Characteristics

- Accepts Multiple Transceivers per INF-8074i
- Compliant Press-Fit Pins or Solder Tails (1x1 Cages)
- Durability: 250 Mating Cycles min

Electrical Characteristics

- Hot Swappable
- Operating Voltage: 3.3 V
- Operating Current: 0.5 A
- Differential Impedance: $100 \Omega + 10 \Omega$
- DWV: 300 V AC
- Insulation Resistance: 1000 MΩ min
- Contact Resistance: 70 mΩ max
- Spring Fingers for Superior EMI Grounding

Packaging

- Tape and Reel Packaging: Connector or Cage
- Tray Packaging: Cage of all Sizes
- Bulk Packaging: Dust Cover

Materials

- Cage
 - o Base Material: Copper Alloy
 - o Plating: Nickel or Tin
 - o Light Pipe: Optical Grade Polycarbonate
 - o Heat Sink: Aluminum Alloy
 - o Heat Sink Clip: Stainless Steel
 - o Dust Cover: Thermoplastic
 - o EMI Ground Tabs: Stainless Steel
 - Connector
 - o Contact Base Material: Copper Alloy
 - o Contact Plating: Gold on Mating Area, Gold or Matte Tin on Termination
 - o Housings: Glass Reinforced, Lead-Free Solder Reflow Process Compatible Thermoplastic, UL94V-0 Rated

Temperature Rating

- Operating Temperature: -55°C to +85°C
- Storage Temperature: -55°C to +105°C

Configurations (Rows x Ports per Row)

- · 2x1 · 2x2 · 2x4 · 2x5
- 2x6 2x8

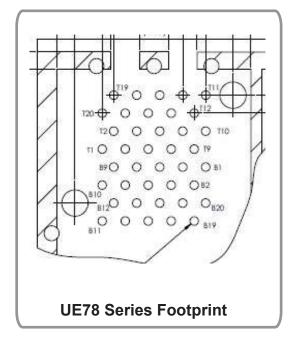
Options

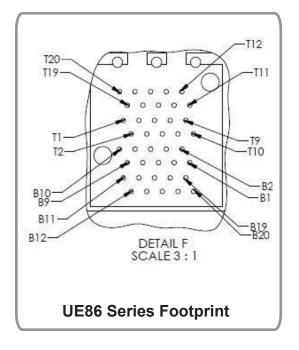
- Dust Cover
- Light Pipe
- Heat Sink (Standard Fin for Final Cage Combo)
- Enhanced EMI Performance Cage



Ordering Information

Cage / Connector)	
	PACKAGING
XX SERIES DESIGNATION	1 - Tray Packaging (Stacked)
UE78 - Standard SFP Cage and Connector (RoHS)	PLATING OPTION: CAGE
UE86 - Standard SFP Cage and Connector with Light Pipes (RoHS)	1 - Bright Tin (for Wave Soldering)
	2 - Nickel
STYLE	3 - Matte Tin (for SMT Soldering)
B - Stacked Connector and Cage Combo (UE78 Series)	
D - 2xN, Small Light Pipe Openings (UE86 Series)	PLATING OPTION: CONNECTOR
K - 2xN, Large Light Pipe Openings (UE86 Series)	X - Various Options Available
L - 2xN, Low Profile Combo (No Light Pipe) (UE78 Series)	Consult Sales or Website for Details
NUMBER OF PORTS IN ROW	DUST COVER OPTION
1 - 2x1	0 - Without Dust Cover
2 - 2x2	D - With Dust Cover (Shipped Loose)
4 - 2x4	
5 - 2x5	HEAT SINK / LIGHT PIPE OPTION
6 - 2x6	0 - No Heat Sink or Light Pipe
8 - 2x8	X - Various Options Available
	Consult Sales or Website for Details
EMI SHIELDING	
1 - Standard	PCB MOUNTING OPTION
2 - Bottom Mylar Tape, No Mid Ground Pins	 7 - Standard X - Various Customer Specific Options Available
3 - No Mid Ground Pins	Consult Sales or Website for Details





Website: www.amphenol-highspeed.com All specifications are subject to change without notice. Email: cages@amphenol-highspeed.com